

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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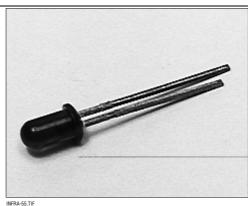




GaAs Infrared Emitting Diode

FEATURES

- T-1 package
- 15° (nominal) beam angle
- 935 nm wavelength
- · Consistent on-axis optical properties
- Mechanically and spectrally matched to SDP8405 phototransistor and SDP8105 photodarlington

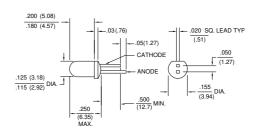


DESCRIPTION

The SEP8505 is a gallium arsenide infrared emitting diode transfer molded in a T-1 red plastic package. Transfer molding of this device assures superior optical centerline performance compared to other molding processes. Lead lengths are staggered to provide a simple method of polarity identification.

OUTLINE DIMENSIONS in inches (mm)

Tolerance 3 plc decimals ±0.005(0.12) 2 plc decimals ±0.020(0.51)



DIM_101.ds4



GaAs Infrared Emitting Diode

ELECTRICAL CHARACTERISTICS (25°C unless otherwise noted)

PARAMETER	SYMBOL	MIN	TYP	MAX	UNITS	TEST CONDITIONS
Irradiance (1)	Н				mW/cm ²	I _F =20 mA
SEP8505-001		0.5				
SEP8505-002		1.0		4.0		
SEP8505-003		2.0		4.0		
Forward Voltage	VF			1.5	V	I _F =20 mA
Reverse Breakdown Voltage	V_{BR}	3.0			V	I _R =10 μA
Peak Output Wavelength	λ_{p}		935		nm	
Spectral Bandwidth	$\Delta \lambda$		50		nm	
Spectral Shift With Temperature	$\Delta \lambda_p / \Delta_T$		0.3		nm/°C	
Beam Angle (2)	Ø		15		degr.	I _F =Constant
Radiation Rise And Fall Time	t _r , t _f		0.7		μs	

- Notes

 1. Measured in mW/cm² into a 0.081(2.05) diameter aperture placed 0.40(10.16) from the lens tip.

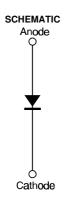
 2. Beam angle is defined as the total included angle between the half intensity points.

ABSOLUTE MAXIMUM RATINGS

(25°C Free-Air Temperature unless otherwise noted) Continuous Forward Current 70 mW (1) Power Dissipation Operating Temperature Range -40°C to 85°C -40°C to 85°C Storage Temperature Range Soldering Temperature (5 sec)

Notes

1. Derate linearly from 25°C free-air temperature at the rate of 0.18 mW/°C.



GaAs Infrared Emitting Diode

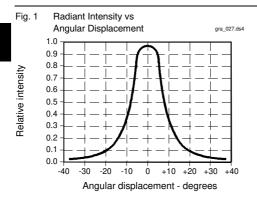
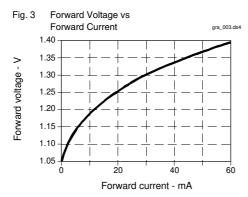
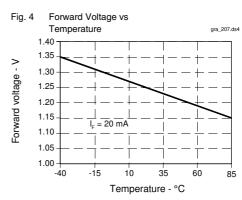
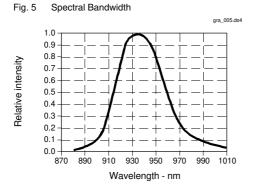
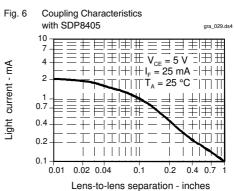


Fig. 2 Radiant Intensity vs Forward Current gra_028.ds4 10.0 Normalized radiant intensity П 2.0 1.0 0.5 ΠШ 0.2 0.1 10 20 30 40 50 100 Forward current - mA

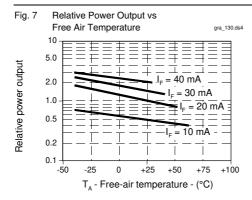








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All Performance Curves Show Typical Values